

NL74VCX16374

Low-Voltage 1.8/2.5/3.3V 16-Bit D-Type Flip-Flop With 3.6V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The NL74VCX16374 is an advanced performance, non-inverting 16-bit D-type flip-flop. It is designed for very high-speed, very low-power operation in 1.8V, 2.5V or 3.3V systems. The VCX16374 is byte controlled, with each byte functioning identically, but independently. Each byte has separate Output Enable and Clock Pulse inputs. These control pins can be tied together for full 16-bit operation.

When operating at 2.5V (or 1.8V) the part is designed to tolerate voltages it may encounter on either inputs or outputs when interfacing to 3.3V busses. It is guaranteed to be over-voltage tolerant to 3.6V.

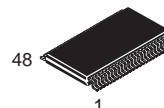
The NL74VCX16374 consists of 16 edge-triggered flip-flops with individual D-type inputs and 3.6V-tolerant 3-state outputs. The clocks (CPn) and Output Enables ($\overline{OE_n}$) are common to all flip-flops within the respective byte. The flip-flops will store the state of individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transition. With the \overline{OE} LOW, the contents of the flip-flops are available at the outputs. When the \overline{OE} is HIGH, the outputs go to the high impedance state. The \overline{OE} input level does not affect the operation of the flip-flops.

- Designed for Low Voltage Operation: $V_{CC} = 1.65\text{--}3.6\text{V}$
- 3.6V Tolerant Inputs and Outputs
- High Speed Operation: 3.0ns max for 3.0 to 3.6V
3.9ns max for 2.3 to 2.7V
7.8ns max for 1.65 to 1.95V
- Static Drive: $\pm 24\text{mA}$ Drive at 3.0V
 $\pm 18\text{mA}$ Drive at 2.3V
 $\pm 6\text{mA}$ Drive at 1.65V
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0\text{V}$
- Near Zero Static Supply Current in All Three Logic States (20 μA)
Substantially Reduces System Power Requirements
- Latchup Performance Exceeds $\pm 300\text{mA}$ @ 125°C
- ESD Performance: Human Body Model >2000V; Machine Model >200V



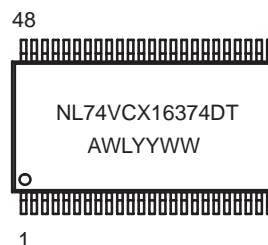
ON Semiconductor

<http://onsemi.com>



TSSOP-48
DT SUFFIX
CASE 1201

MARKING DIAGRAM



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

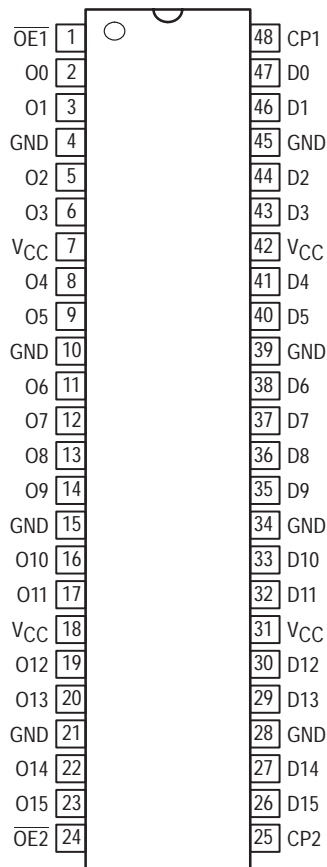
PIN NAMES

Pins	Function
$\overline{OE_n}$	Output Enable Inputs
CPn	Clock Pulse Inputs
D0–D15	Inputs
O0–O15	Outputs

ORDERING INFORMATION

Device	Package	Shipping
NL74VCX16374DT	TSSOP	39 / Rail
NL74VCX16374DTR2	TSSOP	2500 / Reel

NL74VCX16374



**Figure 1. 48-Lead Pinout
(Top View)**

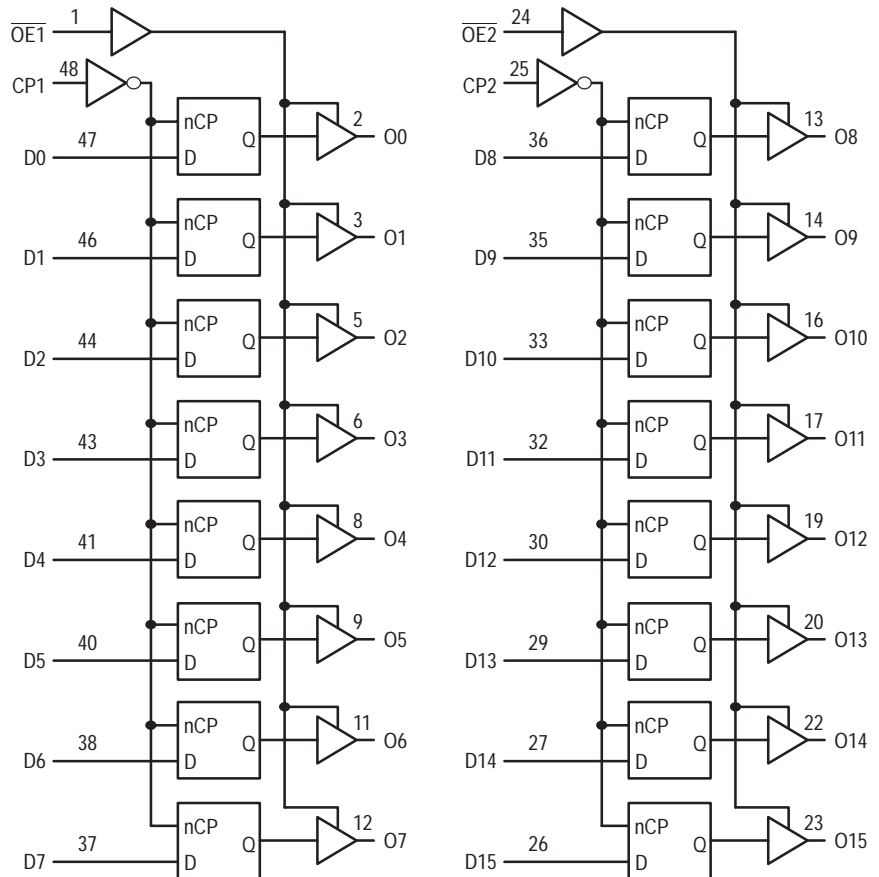
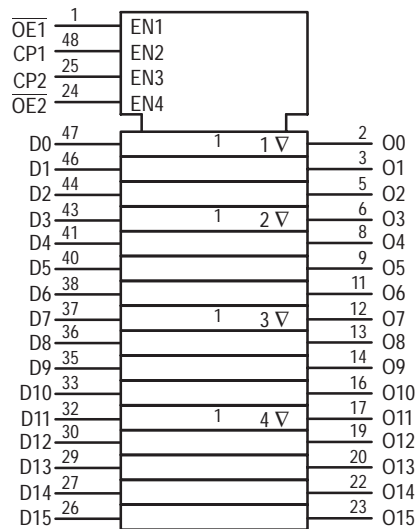


Figure 2. Logic Diagram



Inputs			Outputs	Inputs			Outputs
CP1	OE1	D0:7	O0:7	CP2	OE2	D8:15	O8:15
↑	L	H	H	↑	L	H	H
↑	L	L	L	↑	L	L	L
X	L	X	O0	X	L	X	O0
X	H	X	Z	X	H	X	Z

H = High Voltage Level; L = Low Voltage Level; Z = High Impedance State; ↑ = Low-to-High Transition; X = High or Low Voltage Level and Transitions Are Acceptable, for I_{CC} reasons, DO NOT FLOAT Inputs. O0 = No Change.

ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V_{CC}	DC Supply Voltage	-0.5 to +4.6		V
V_I	DC Input Voltage	$-0.5 \leq V_I \leq +4.6$		V
V_O	DC Output Voltage	$-0.5 \leq V_O \leq +4.6$	Output in 3-State	V
		$-0.5 \leq V_O \leq V_{CC} + 0.5$	Note 1.; Outputs Active	V
I_{IK}	DC Input Diode Current	-50	$V_I < GND$	mA
I_{OK}	DC Output Diode Current	-50	$V_O < GND$	mA
		+50	$V_O > V_{CC}$	mA
I_O	DC Output Source/Sink Current	± 50		mA
I_{CC}	DC Supply Current Per Supply Pin	± 100		mA
I_{GND}	DC Ground Current Per Ground Pin	± 100		mA
T_{STG}	Storage Temperature Range	-65 to +150		°C

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

1. I_O absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	1.65	3.3	3.6	V
	Operating Data Retention Only	1.2	3.3	3.6	
V _I	Input Voltage	−0.3		3.6	V
V _O	Output Voltage	0		V _{CC}	V
	(Active State) (3-State)	0		3.6	
I _{OH}	HIGH Level Output Current, V _{CC} = 3.0V – 3.6V			−24	mA
I _{OL}	LOW Level Output Current, V _{CC} = 3.0V – 3.6V			24	mA
I _{OH}	HIGH Level Output Current, V _{CC} = 2.3V – 2.7V			−18	mA
I _{OL}	LOW Level Output Current, V _{CC} = 2.3V – 2.7V			18	mA
I _{OH}	HIGH Level Output Current, V _{CC} = 1.65 – 1.95V			−6	mA
I _{OL}	LOW Level Output Current, V _{CC} = 1.65 – 1.95V			6	mA
T _A	Operating Free-Air Temperature	−40		+85	°C
Δt/ΔV	Input Transition Rise or Fall Rate, V _{IN} from 0.8V to 2.0V, V _{CC} = 3.0V	0		10	ns/V

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DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T _A = -40°C to +85°C		Unit
			Min	Max	
V _{IH}	HIGH Level Input Voltage (Note 2.)	1.65V ≤ V _{CC} < 2.3V	0.65 x V _{CC}		V
		2.3V ≤ V _{CC} ≤ 2.7V	1.6		
		2.7V < V _{CC} ≤ 3.6V	2.0		
V _{IL}	LOW Level Input Voltage (Note 2.)	1.65V ≤ V _{CC} < 2.3V		0.35 x V _{CC}	V
		2.3V ≤ V _{CC} ≤ 2.7V		0.7	
		2.7V < V _{CC} ≤ 3.6V		0.8	
V _{OH}	HIGH Level Output Voltage	1.65V ≤ V _{CC} ≤ 3.6V; I _{OH} = -100μA	V _{CC} - 0.2		V
		V _{CC} = 1.65V; I _{OH} = -6mA	1.25		
		V _{CC} = 2.3V; I _{OH} = -6mA	2.0		
		V _{CC} = 2.3V; I _{OH} = -12mA	1.8		
		V _{CC} = 2.3V; I _{OH} = -18mA	1.7		
		V _{CC} = 2.7V; I _{OH} = -12mA	2.2		
		V _{CC} = 3.0V; I _{OH} = -18mA	2.4		
		V _{CC} = 3.0V; I _{OH} = -24mA	2.2		
V _{OL}	LOW Level Output Voltage	1.65V ≤ V _{CC} ≤ 3.6V; I _{OL} = 100μA		0.2	V
		V _{CC} = 1.65V; I _{OL} = 6mA		0.3	
		V _{CC} = 2.3V; I _{OL} = 12mA		0.4	
		V _{CC} = 2.3V; I _{OL} = 18mA		0.6	
		V _{CC} = 2.7V; I _{OL} = 12mA		0.4	
		V _{CC} = 3.0V; I _{OL} = 18mA		0.4	
		V _{CC} = 3.0V; I _{OL} = 24mA		0.55	
I _I	Input Leakage Current	1.65V ≤ V _{CC} ≤ 3.6V; 0V ≤ V _I ≤ 3.6V		±5.0	μA
I _{OZ}	3-State Output Current	1.65V ≤ V _{CC} ≤ 3.6V; 0V ≤ V _O ≤ 3.6V; V _I = V _{IH} or V _{IL}		±10	μA
I _{OFF}	Power-Off Leakage Current	V _{CC} = 0V; V _I or V _O = 3.6V		10	μA
I _{CC}	Quiescent Supply Current (Note 3.)	1.65V ≤ V _{CC} ≤ 3.6V; V _I = GND or V _{CC}		20	μA
		1.65V ≤ V _{CC} ≤ 3.6V; 3.6V ≤ V _I , V _O ≤ 3.6V		±20	μA
ΔI _{CC}	Increase in I _{CC} per Input	2.7V < V _{CC} ≤ 3.6V; V _{IH} = V _{CC} - 0.6V		750	μA

2. These values of V_I are used to test DC electrical characteristics only.

3. Outputs disabled or 3-state only.

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AC CHARACTERISTICS (Note 4.; $t_R = t_F = 2.0\text{ns}$; $C_L = 30\text{pF}$; $R_L = 500\Omega$)

Symbol	Parameter	Waveform	Limits						Unit
			T _A = −40°C to +85°C						
			V _{CC} = 3.0V to 3.6V		V _{CC} = 2.3V to 2.7V		V _{CC} = 1.65 to 1.95V		
			Min	Max	Min	Max	Min	Max	
f _{max}	Clock Pulse Frequency	1	250		200		100		MHz
t _{PLH}	Propagation Delay	1	0.8	3.0	1.0	3.9	1.5	7.8	ns
t _{PHL}	CP to On		0.8	3.0	1.0	3.9	1.5	7.8	
t _{PZH}	Output Enable Time to	2	0.8	3.5	1.0	4.6	1.5	9.2	ns
t _{PZL}	High and Low Level		0.8	3.5	1.0	4.6	1.5	9.2	
t _{PHZ}	Output Disable Time From	2	0.8	3.5	1.0	3.8	1.5	6.8	ns
t _{PLZ}	High and Low Level		0.8	3.5	1.0	3.8	1.5	6.8	
t _s	Setup Time, High or Low Dn to CP	3	1.5		1.5		2.5		ns
t _h	Hold Time, High or Low Dn to CP	3	1.0		1.0		1.0		ns
t _w	CP Pulse Width, High	3	1.5		1.5		4.0		ns
t _{OSHL}	Output–to–Output Skew			0.5		0.5		0.75	ns
t _{OSLH}	(Note 5.)			0.5		0.5		0.75	

4. For $C_L = 50\text{pF}$, add approximately 300ps to the AC maximum specification.

5. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Characteristic	Condition	$T_A = +25^\circ\text{C}$	Unit
			Typ	
V_{OLP}	Dynamic LOW Peak Voltage (Note 6.)	$V_{CC} = 1.8\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	0.25	V
		$V_{CC} = 2.5\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	0.6	
		$V_{CC} = 3.3\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	0.8	
V_{OLV}	Dynamic LOW Valley Voltage (Note 6.)	$V_{CC} = 1.8\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	-0.25	V
		$V_{CC} = 2.5\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	-0.6	
		$V_{CC} = 3.3\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	-0.8	
V_{OHV}	Dynamic HIGH Valley Voltage (Note 7.)	$V_{CC} = 1.8\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	1.5	V
		$V_{CC} = 2.5\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	1.9	
		$V_{CC} = 3.3\text{V}, C_L = 30\text{pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{V}$	2.2	

6. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

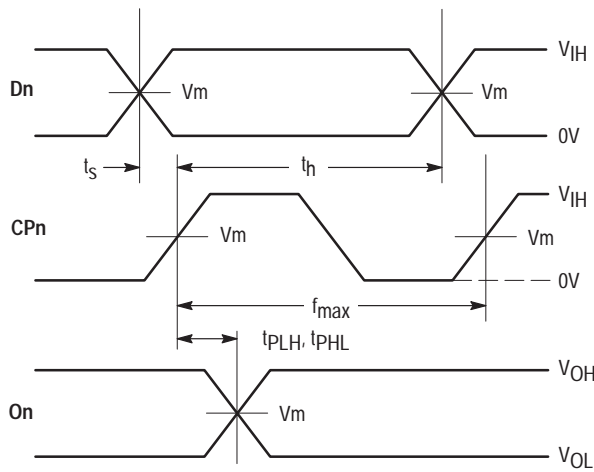
7. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the HIGH state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C_{IN}	Input Capacitance	Note 8.	6	pF
C_{OUT}	Output Capacitance	Note 8.	7	pF
C_{PD}	Power Dissipation Capacitance	Note 8., 10MHz	20	pF

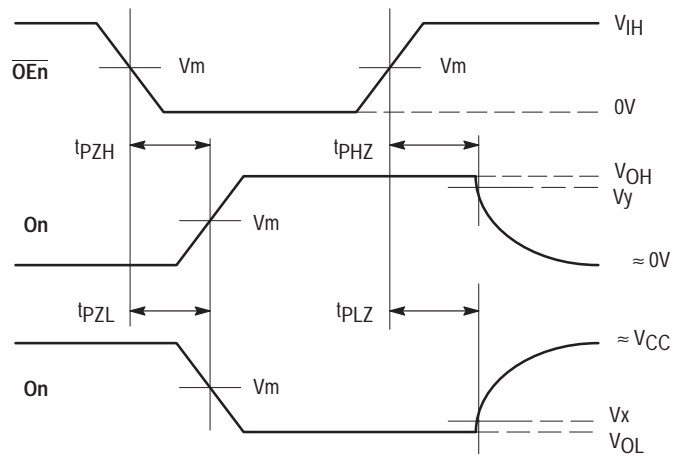
8. $V_{CC} = 1.8, 2.5$ or 3.3V ; $V_I = 0\text{V}$ or V_{CC} .

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WAVEFORM 1 – PROPAGATION DELAYS, SETUP AND HOLD TIMES

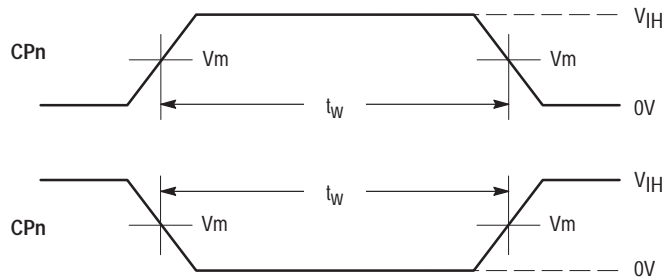
$t_R = t_F = 2.0\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$



WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES

$t_R = t_F = 2.0\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$

Figure 3. AC Waveforms

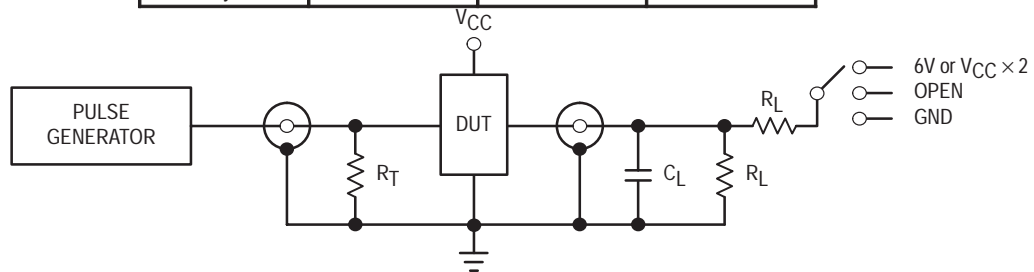


WAVEFORM 3 – PULSE WIDTH

$t_R = t_F = 2.0\text{ns}$ (or fast as required) from 10% to 90%

Figure 4. AC Waveforms

Symbol	V _{CC}		
	3.3V ±0.3V	2.5V ±0.2V	1.8V ±0.15V
V _{IH}	2.7V	V _{CC}	V _{CC}
V _m	1.5V	V _{CC} /2	V _{CC} /2
V _x	V _{OL} + 0.3V	V _{OL} + 0.15V	V _{OL} + 0.15V
V _y	V _{OH} - 0.3V	V _{OH} - 0.15V	V _{OH} - 0.15V



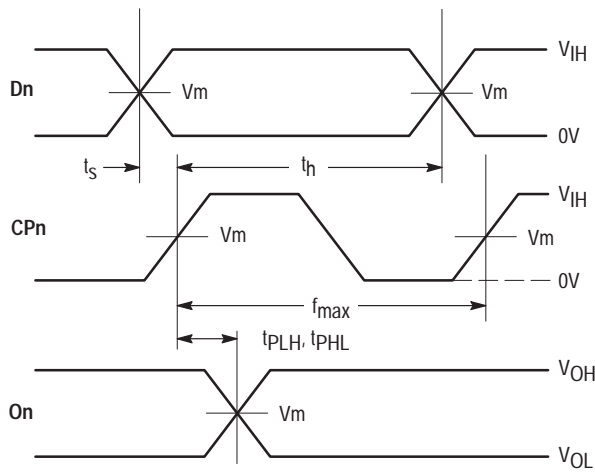
TEST	SWITCH
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	6V at V _{CC} = 3.3 ±0.3V; V _{CC} × 2 at V _{CC} = 2.5 ±0.2V; 1.8V ±0.15V
t _{PZH} , t _{PHZ}	GND

$C_L = 30\text{pF}$ or equivalent (Includes jig and probe capacitance)

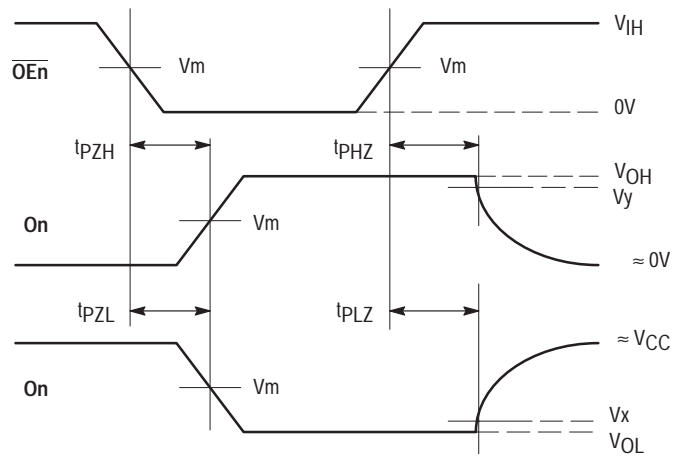
$R_L = 500\Omega$ or equivalent

$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 5. Test Circuit

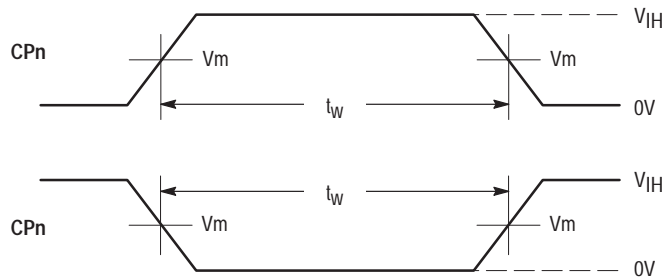


WAVEFORM 4 – PROPAGATION DELAYS, SETUP AND HOLD TIMES
 $t_R = t_F = 2.0\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$



WAVEFORM 5 – OUTPUT ENABLE AND DISABLE TIMES
 $t_R = t_F = 2.0\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$

Figure 6. AC Waveforms



WAVEFORM 6 – PULSE WIDTH
 $t_R = t_F = 2.0\text{ns}$ (or fast as required) from 10% to 90%

Figure 7. AC Waveforms

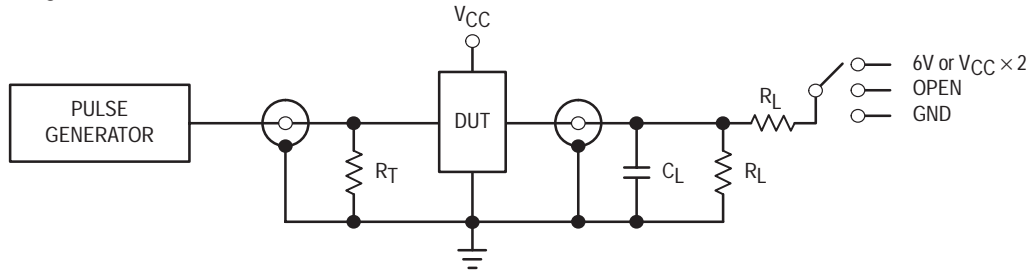
Symbol	VCC	
	3.3V ±0.3V	2.7V
V _{IH}	2.7V	2.7V
V _m	1.5V	1.5V
V _x	V _{OL} + 0.3V	V _{OL} + 0.3V
V _y	V _{OH} - 0.3V	V _{OH} - 0.3V

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AC CHARACTERISTICS ($t_R = t_F = 2.0\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$)

Symbol	Parameter	Waveform	Limits				Unit
			T _A = −40°C to +85°C				
			V _{CC} = 3.0V to 3.6V		V _{CC} = 2.7V		
			Min	Max	Min	Max	
f _{max}	Clock Pulse Frequency	4	150		150		MHz
t _{PLH} t _{PHL}	Propagation Delay CP to On	4	1.0 1.0	4.2 4.2		4.9 4.9	ns
t _{PZH} t _{PZL}	Output Enable Time to High and Low Level	5	1.0 1.0	4.8 4.8		5.9 5.9	ns
t _{PHZ} t _{PLZ}	Output Disable Time From High and Low Level	5	1.0 1.0	4.3 4.3		4.7 4.7	ns
t _{OSHL} t _{OSLH}	Output-to-Output Skew (Note 9.)			0.5 0.5		0.5 0.5	ns

9. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.



TEST	SWITCH
t_{PLH} , t_{PHL}	Open
t_{PZL} , t_{PLZ}	6V at $V_{CC} = 3.3 \pm 0.3\text{V}$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2\text{V}$; $1.8\text{V} \pm 0.15\text{V}$
t_{PZH} , t_{PHZ}	GND

$C_L = 50\text{pF}$ or equivalent (Includes jig and probe capacitance)

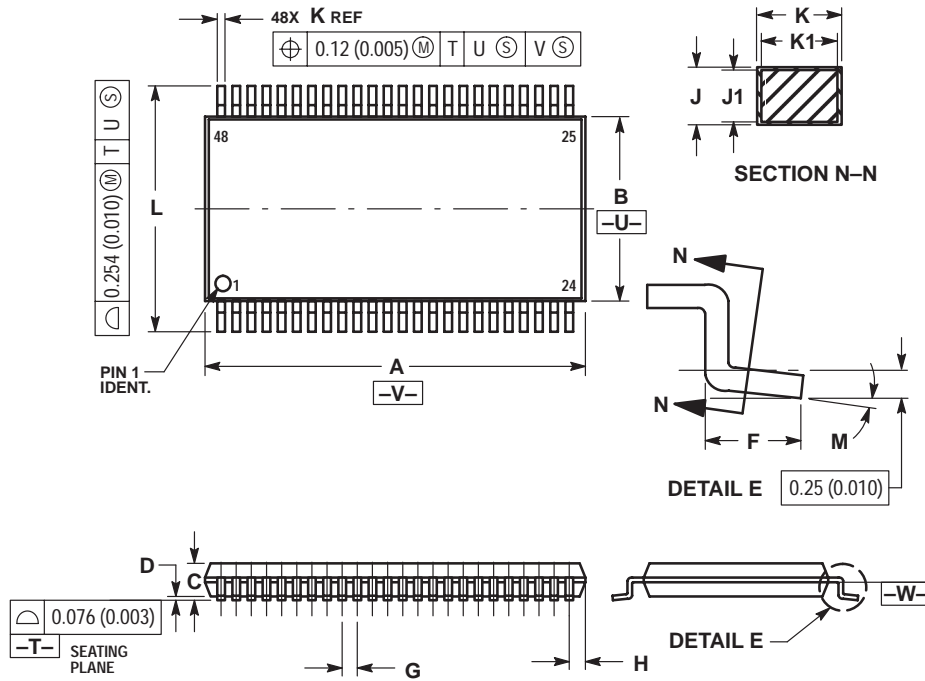
$R_L = 500\Omega$ or equivalent

$R_T = Z_{\text{OUT}}$ of pulse generator (typically 50Ω)

Figure 8. Test Circuit

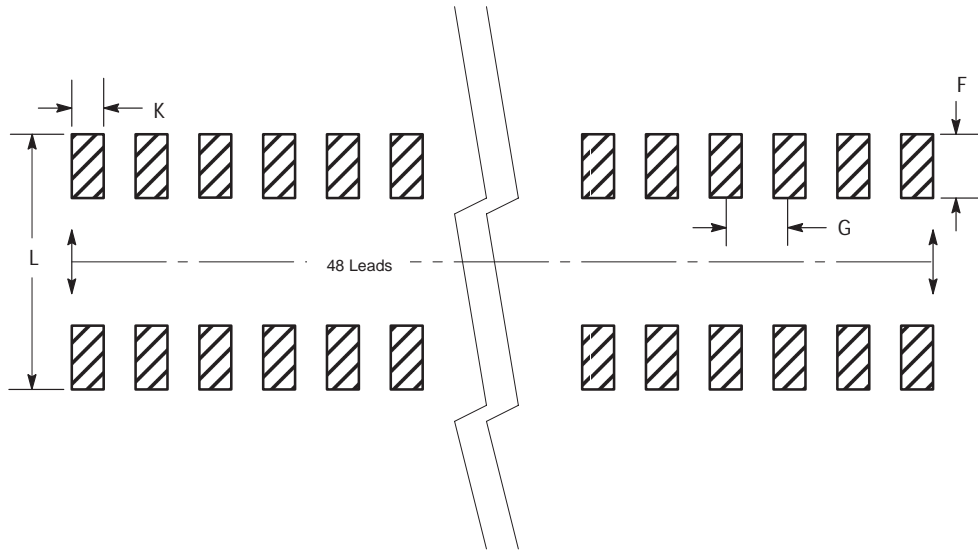
PACKAGE DIMENSIONS

TSSOP
DT SUFFIX
CASE 1201-01
ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.40	12.60	0.488	0.496
B	6.00	6.20	0.236	0.244
C	—	1.10	—	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC		0.0197 BSC	
H	0.37	—	0.015	—
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0 °	8 °	0 °	8 °



Package Footprint

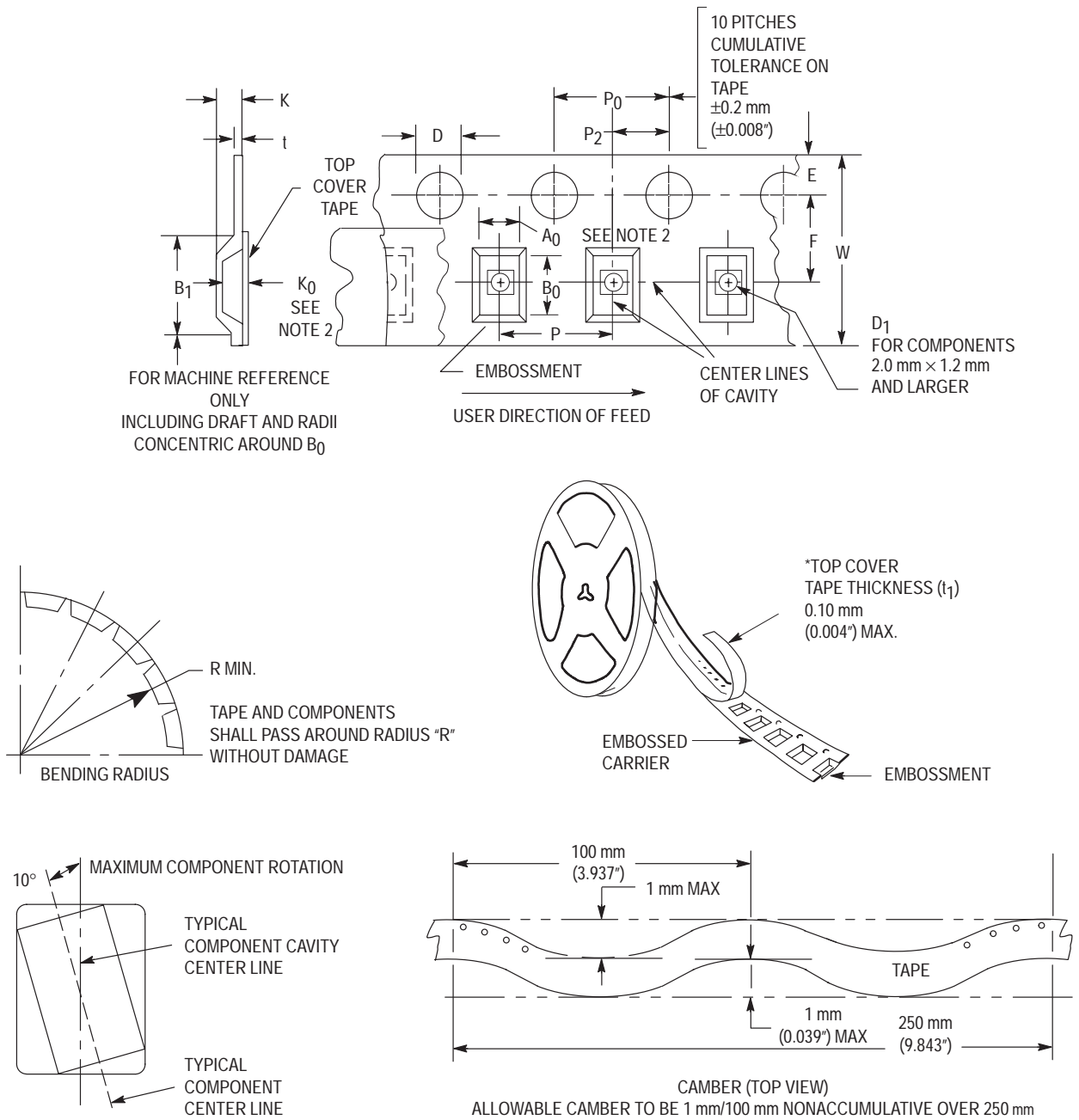


Figure 9. Carrier Tape Specifications

EMBOSSED CARRIER DIMENSIONS (See Notes 1 and 2)

Tape Size	B_1 Max	D	D_1	E	F	K	P	P_0	P_2	R	T	W
24mm	20.1mm (0.791")	1.5 + 0.1mm - 0.0 (0.059 + 0.004" - 0.0)	1.5mm Min (0.060")	1.75 ± 0.1 mm (0.069 ± 0.004 ")	11.5 ± 0.10 mm (0.453 ± 0.004 ")	11.9 mm Max (0.468")	16.0 ± 0.1 mm (0.63 ± 0.004 ")	4.0 ± 0.1 mm (0.157 ± 0.004 ")	2.0 ± 0.1 mm (0.079 ± 0.004 ")	30 mm (1.18")	0.6 mm (0.024")	24.3 mm (0.957")

1. Metric Dimensions Govern—English are in parentheses for reference only.
2. A_0 , B_0 , and K_0 are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity

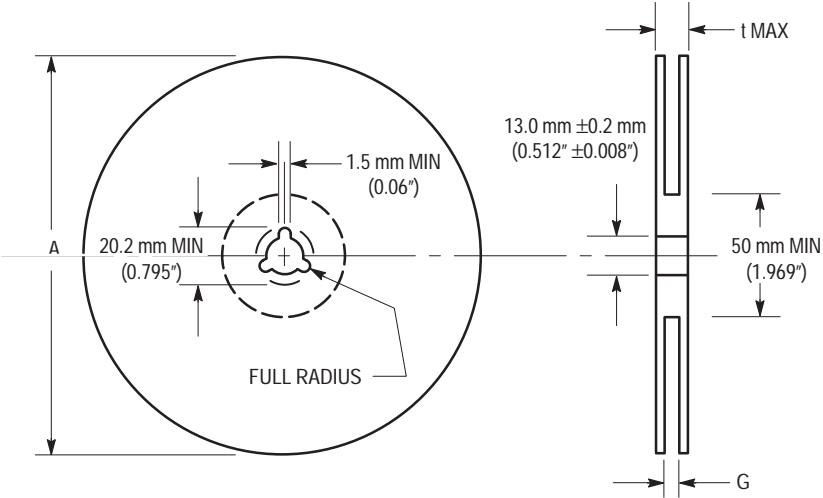


Figure 10. Reel Dimensions

REEL DIMENSIONS

Tape Size	A Max	G	t Max
24 mm	360 mm (14.173")	24.4 mm + 2.0 mm, -0.0 (0.961" + 0.078", -0.00)	30.4 mm (1.197")

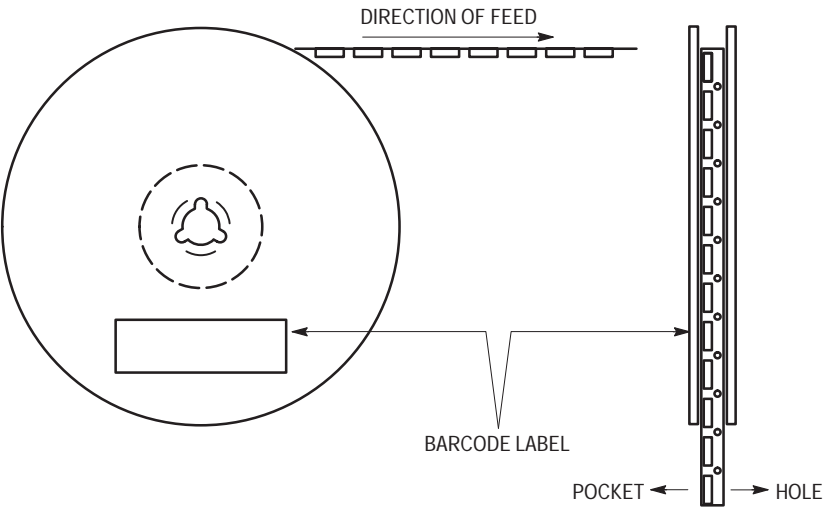


Figure 11. Reel Winding Direction

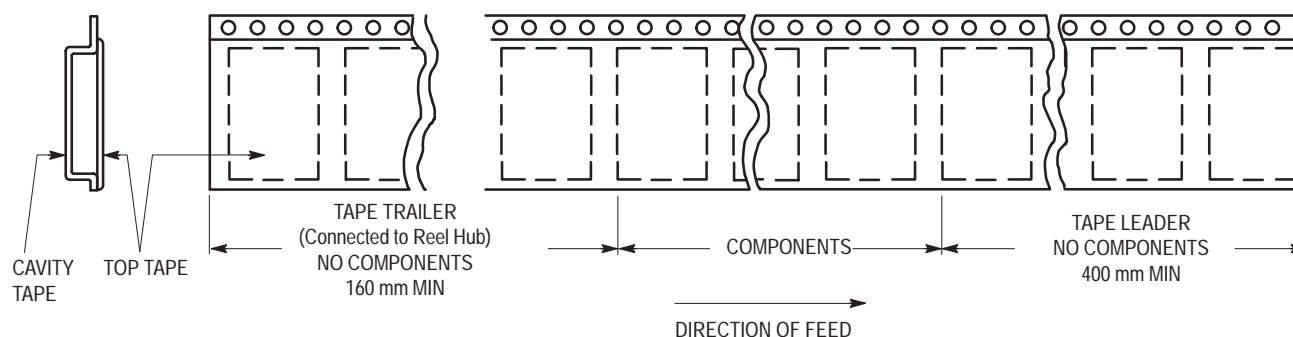


Figure 12. Tape Ends for Finished Goods

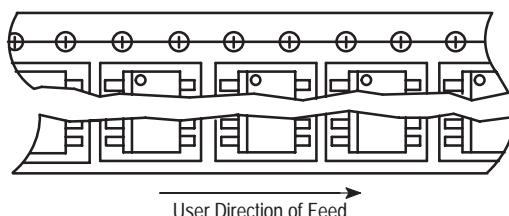



Figure 13. Reel Configuration

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